**IRFF420** 



# REPETITIVE AVALANCHE AND dv/dt RATED HEXFET<sup>®</sup> TRANSISTORS THRU-HOLE TO-205AF (TO-39)

#### **Product Summary**

Part Number	BVDSS	RDS(on)	Ι <sub>D</sub>
IRFF420	500V	3.0Ω	1.5A

# 500V, N-CHANNEL REF: MIL-PRF-19500/555

**JANTX2N6794** 

**JANTXV2N6794** 



## Description

The HEXFET<sup>®</sup> technology is the key to International Rectifier's HiRel advanced line of power MOSFET transistors. The efficient geometry and unique processing of this latest "State of the Art" design achieves: very low on state resistance combined with high trans conductance.

The HEXFET transistors also feature all of the well established advantages of MOSFETs such as voltage control, very fast switching and temperature stability of the electrical parameters.

They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high energy pulse circuits.

#### Features

- Repetitive Avalanche Ratings
- Dynamic dv/dt Rating
- Hermetically Sealed
- Simple Drive Requirements
- ESD Rating: Class 1B per MIL-STD-750, Method 1020

Symbol	Parameter	Value	Units	
I <sub>D1</sub> @ V <sub>GS</sub> = 10V, T <sub>C</sub> = 25°C	Continuous Drain Current	1.5		
$I_{D2} @ V_{GS} = 10V, T_C = 100^{\circ}C$	Continuous Drain Current	1.0	А	
I <sub>DM</sub> @ T <sub>C</sub> = 25°C	Pulsed Drain Current ①	6.0	l .	
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Maximum Power Dissipation	20	W	
	Linear Derating Factor	0.16	W/°C	
V <sub>GS</sub>	Gate-to-Source Voltage	± 20	V	
E <sub>AS</sub>	Single Pulse Avalanche Energy ②	0.242	mJ	
I <sub>AR</sub>	Avalanche Current ①	6.0   20   0.16   ± 20   gy ② 0.242   2.2   ① 2.0	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy ①	2.0	mJ	
dv/dt	Peak Diode Recovery dv/dt ③	3.5	V/ns	
TJ	Operating Junction and	55 to + 150	°C	
T <sub>STG</sub>	Storage Temperature Range	-55 10 + 150		
	Lead Temperature	300 (0.063 in. /1.6 mm from case for 10s)		
	Weight	0.98 (Typical)	g	

#### **Absolute Maximum Ratings**

For Footnotes, refer to the page 2.



Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)								
Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions		
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	500			V	$V_{GS} = 0V, I_{D} = 1.0mA$		
$\Delta BV_{\text{DSS}}/\Delta T_{\text{J}}$	Breakdown Voltage Temp. Coefficient		0.43		V/°C	Reference to 25°C, $I_D = 1.0$ mA		
D	Statia Drain ta Sauraa On Dagiatanaa			3.0	Ω	V <sub>GS</sub> = 10V, I <sub>D2</sub> = 1.0A ④		
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance			3.1		V <sub>GS</sub> = 10V, I <sub>D1</sub> = 1.5A ④		
V <sub>GS(th)</sub>	Gate Threshold Voltage	2.0		4.0	V	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A		
Gfs	Forward Transconductance	1.0			S	V <sub>DS</sub> = 15V, I <sub>D2</sub> = 1.0A ④		
I <sub>DSS</sub>	Zero Gate Voltage Drain Current			25	A	$V_{DS}$ = 400 V, $V_{GS}$ = 0V		
				250	μA	$V_{DS}$ = 400V, $V_{GS}$ = 0V, $T_{J}$ =125°C		
I <sub>GSS</sub>	Gate-to-Source Leakage Forward			100	nA	V <sub>GS</sub> = 20V		
	Gate-to-Source Leakage Reverse			-100	ПА	V <sub>GS</sub> = -20V		
$Q_{G}$	Total Gate Charge	7.3		25		I <sub>D1</sub> = 1.5A		
$Q_{GS}$	Gate-to-Source Charge	0.1		6.0	nC	V <sub>DS</sub> = 250V		
$Q_{GD}$	Gate-to-Drain ('Miller') Charge	3.7		18		V <sub>GS</sub> = 10V		
t <sub>d(on)</sub>	Turn-On Delay Time			40		V <sub>DD</sub> = 225V		
tr	Rise Time			30		I <sub>D1</sub> = 1.5A		
t <sub>d(off)</sub>	Turn-Off Delay Time			60	ns	R <sub>G</sub> = 7.5Ω		
t <sub>f</sub>	Fall Time			30		V <sub>GS</sub> = 10V		
Ls +L <sub>D</sub>	Total Inductance		7.0		nH	Measured from Drain lead (6mm / 0.25 in from package) to Source lead (6mm/ 0.25 in from package) with Source wire internally bonded from Source pin to Drain pin		
C <sub>iss</sub>	Input Capacitance		350			V <sub>GS</sub> = 0V		
C <sub>oss</sub>	Output Capacitance		80		pF	V <sub>DS</sub> = 25V		
C <sub>rss</sub>	Reverse Transfer Capacitance		35			f = 1.0MHz		

### Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

## **Source-Drain Diode Ratings and Characteristics**

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
ls	Continuous Source Current (Body Diode)			1.5	^	
I <sub>SM</sub>	Pulsed Source Current (Body Diode) ①			6.0	A	
V <sub>SD</sub>	Diode Forward Voltage			1.2	V	$T_J = 25^{\circ}C, I_S = 1.5A, V_{GS} = 0V$
t <sub>rr</sub>	Reverse Recovery Time			900	ns	$T_J = 25^{\circ}C, I_F = 1.5A, V_{DD} \le 50V$
Q <sub>rr</sub>	Reverse Recovery Charge			5.9	μC	di/dt = 100A/µs ④
t <sub>on</sub>	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_{\text{S}}\text{+}L_{\text{D}})$				

#### **Thermal Resistance**

Symbol	Parameter	Min.	Тур.	Max.	Units	
$R_{ ext{ heta}JC}$	Junction-to-Case			6.25	°C/W	
R <sub>0JA</sub>	Junction-to-Ambient (Typical Socket Mount)			175	C/ VV	

#### Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- $@~V_{\text{DD}}$  = 50V, starting  $T_{\text{J}}$  = 25°C, L = 100 $\mu\text{H},$  Peak I\_L = 2.2A
- $\ \ \, \mathbb{I}_{SD} \leq 1.5 \text{A}, \, \text{di/dt} \leq 50 \text{A}/\mu \text{s}, \, \text{V}_{\text{DD}} \leq 500 \text{V}, \, \text{T}_{\text{J}} \leq 150^{\circ}\text{C}, \, \text{Suggested} \, \text{R}_{\text{G}} \text{=} 7.5 \, \Omega \\ \ \ \, \mathbb{I}_{SD} \leq 1.5 \text{A}, \, \text{di/dt} \approx 1$
- ④ Pulse width  $\leq$  300 µs; Duty Cycle  $\leq$  2%

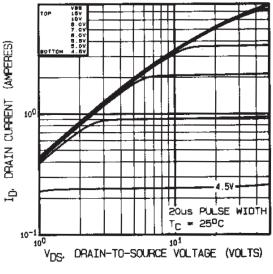


Fig 1. Typical Output Characteristics

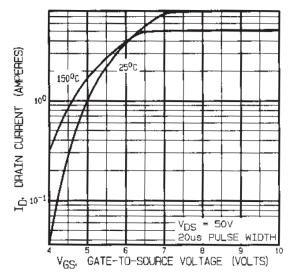
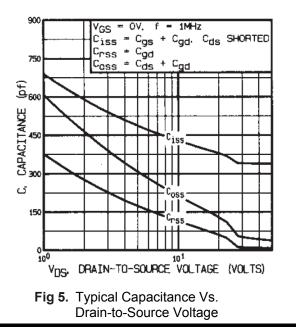
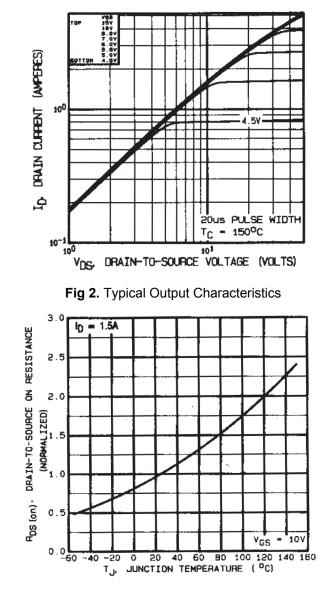
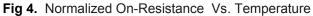
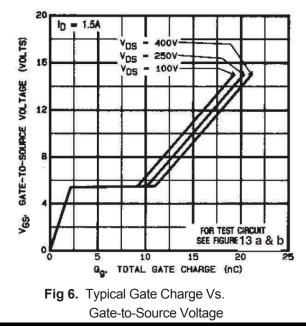


Fig 3. Typical Transfer Characteristics



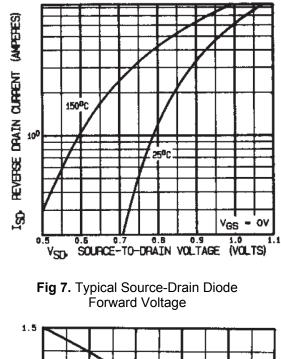


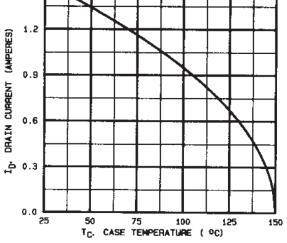




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## IRFF420 JANTX2N6794/JANTXV2N6794

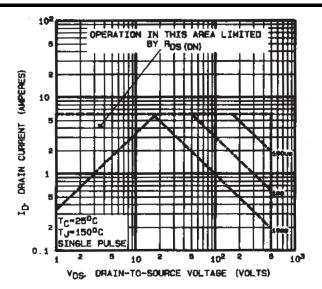
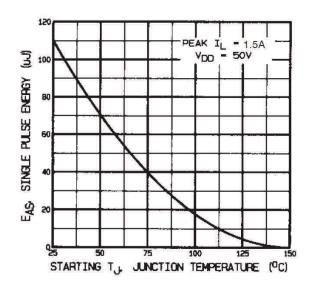
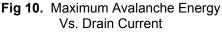


Fig 8. Maximum Safe Operating Area





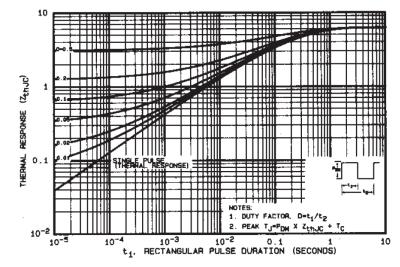


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

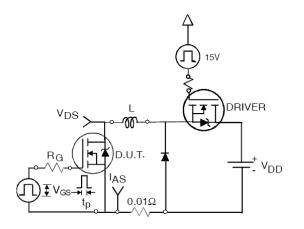
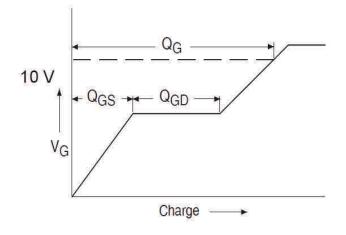


Fig 12a. Unclamped Inductive Test Circuit





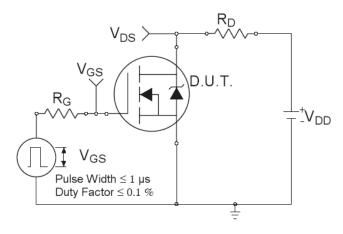
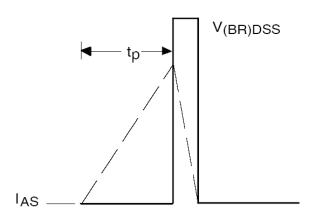
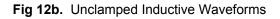


Fig 14a. Switching Time Test Circuit





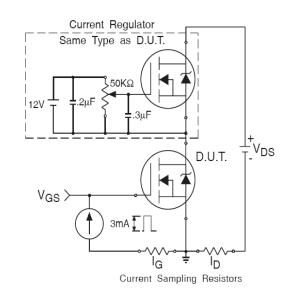
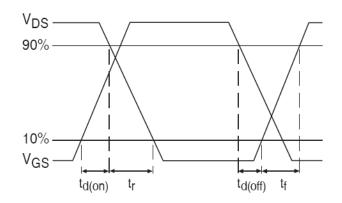


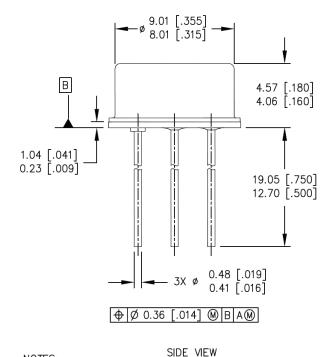
Fig 13b. Gate Charge Test Circuit







## Case Outline and Dimensions - TO-205AF (TO-39)

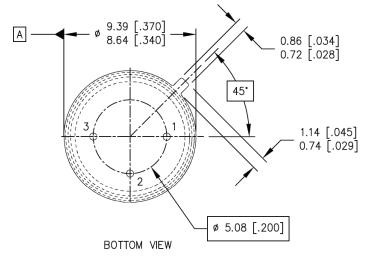


DIMENSIONING AND TOLERANCING PER ASME 14.5M-1994.

DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].

CONFORMS TO JEDEC OUTLINE TO-205AF (TO-39).

CONTROLLING DIMENSION: INCH.



LEGEND 1- SOURCE 2- GATE 3- DRAIN (CONNECTED TO THE CASE)

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NOTES:

1. 2.

3. 4.



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